

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
BYONG DEOK CHOI	07/13/2017
DONG KYUE KIM	07/13/2017
SANG SEON PARK	07/13/2017
KWANG HYUN JEE	07/13/2017
DONG HYUN KIM	07/13/2017
RECEIVING PARTY DATA	
Name:	ICTK CO., LTD.
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City:	GYEONGGI-DO
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15033554
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SIGNATURE:	/Ellen McKean/
DATE SIGNED:	08/09/2017
Total Attachments: 2	
source=Assignment (as filed) 8-9-17#page1.tif	

ASSIGNMENT

WHEREAS, I/we, the following named inventor(s):

1. Byong Deok Choi, residing in Seoul, Republic of Korea;
2. Dong Kyue Kim, residing in Seoul, Republic of Korea;
3. Sang Seon Park, residing in Gyeonggi-do, Republic of Korea;
4. Kwang Hyun Jee, residing in Gyeonggi-do, Republic of Korea; and
5. Dong Hyun Kim, residing in Gyeonggi-do, Republic of Korea;

have invented an invention entitled **IC CHIP AND AUTHENTICATION METHOD FOR USER AUTHENTICATION**, for which I/we have executed an application for Letters Patent of the United States (check one):

() on the date I/we executed this assignment;

() as U.S. Patent Application No. _____, filed _____;

(X) as International Application No. PCT/KR2014/000427, filed January 15, 2014;

I/we authorize the attorneys/agents authorized to act under Customer Number 145572 to insert the filing date and application number of said application when known.

WHEREAS, ICTK CO., LTD., ("Assignee"), a Republic of Korea corporation, having its principal place of business at 3rd Floor, 323, Pangyo-ro, Bundang-gu, Seongnam-si, Gyeonggi-do, 463-400, Republic of Korea, is desirous of acquiring an interest therein;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I/we, the above named inventor(s), have sold, assigned, and transferred, and by these presents do sell, assign, and transfer unto Assignee, the full and exclusive right to the above-identified invention in the United States and its territorial possessions and in all foreign countries, and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries, and in and to any and all divisions, reissues, continuations and extensions thereof, and all priority rights under all present or future conventions and treaties, and any provisional applications for which priority is claimed.

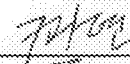
I/We hereby authorize and request the Patent Office officials in the United States and any and all foreign countries to issue any and all of said Letters Patent, when granted, to Assignee, as the assignee of my/our entire right, title and interest in and to the same, for the sole use of the Assignee, their successors and assigns.

Further, I/we agree that I/we will communicate to Assignee, or their representatives, any facts known to me/us respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitution, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to Assignee, make all rightful oaths and generally do everything possible to aid Assignee, their successors and assigns, to obtain and enforce proper protection for said invention in the United States and in any and all foreign countries.

IN TESTIMONY WHEREOF, I/we have hereunto set my/our hand(s) on the dates indicated below.

1. Inventor Name: <u>Byong Deok Choi</u>	Signature: <u>[Signature]</u>	Date: <u>July 13, 2011</u>
2. Inventor Name: <u>Dong Kyue Kim</u>	Signature: <u>[Signature]</u>	Date: <u>July 13, 2011</u>
3. Inventor Name: <u>Sang Seon Park</u>	Signature: <u>[Signature]</u>	Date: <u>July 13, 2011</u>

IN TESTIMONY WHEREOF, I/we have hereunto set my/our hand(s) on the dates indicated below.

4. Inventor Name: Kwang Hyun Jee Signature:  Date: July 13, 2017

5. Inventor Name: Dong Hyun Kim Signature:  Date: July 13, 2017